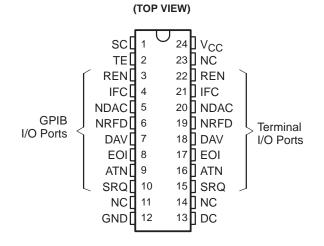
SLLS020C - JUNE 1986 - REVISED MAY 1995

- Meets IEEE Standard 488-1978 (GPIB)
- 8-Channel Bidirectional Transceiver
- **Designed to Implement Control Bus** Interface
- **Designed for Multicontrollers**
- **High-Speed Advanced Low-Power Schottky**
- Low-Power Dissipation . . . 46 mW Max per Channel
- Fast Propagation Times . . . 20 ns Max
- **High-Impedance PNP Inputs**
- Receiver Hysteresis . . . 650 mV Typ
- **Bus-Terminating Resistors Provided on Driver Outputs**
- No Loading of Bus When Device Is Powered Down ($V_{CC} = 0$)
- Power-Up/Power-Down Protection (Glitch Free)

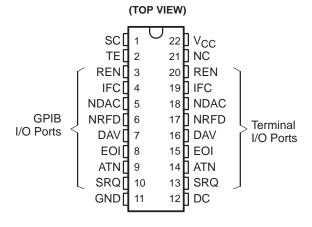
description

The SN75ALS162 eight-channel general-purpose interface bus (GPIB) transceiver is a monolithic, high-speed, advanced low-power Schottky process device designed to provide the bus-management and data-transfer signals between operating units of a multiple-controller instrumentation system. When combined with the SN75ALS160 octal bus transceiver, the SN75ALS162 provides the complete 16-wire interface for the IEEE 488 bus.

The SN75ALS162 features eight driver-receiver pairs connected in a front-to-back configuration to form input/output (I/O) ports at both the bus and terminal sides. The direction of data through these driver-receiver pairs is determined by the DC, TE, and SC enable signals. The SC input allows the REN and IFC transceivers to be controlled independently.



DW PACKAGE



N PACKAGE

NC-No internal connection

The driver outputs (GPIB I/O ports) feature active bus-terminating resistor circuits designed to provide a high impedance to the bus when $V_{CC} = 0$. The drivers are designed to handle loads up to 48 mA of sink current. Each receiver features pnp transistor inputs for high input impedance and hysteresis of 400 mV minimum for increased noise immunity. All receivers have 3-state outputs to present a high impedance to the terminal when

The SN75ALS162 is characterized for operation from 0°C to 70°C.



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SLLS020C - JUNE 1986 - REVISED MAY 1995

RECEIVE/TRANSMIT FUNCTION TABLE

CONTROLS				BUS-MANAGEMENT CHANNELS				DATA-TRANSFER CHANNELS			
SC	DC	TE	ATN†	ATN [†]	SRQ	REN	IFC	EOI	DAV	NDAC	NRFD
				(controll	ed by DC)	(controlle	ed by SC)		(co	ntrolled by	TE)
	Н	Н	Н	R	т			Т	т	R	R
	Н	Н	L	K	ı			R	ľ	K	K
	L	L	Н	т	R			R	R	т	_
	L	L	L	I	ĸ			T	K	I	ı
	Н	L	Х	R	Т			R	R	Т	Т
	L	Н	Х	Т	R			Т	Т	R	R
Н						Т	T				
L						R	R				

H = high level, L = low level, R = receive, T = transmit, X = irrelevant

Direction of data transmission is from the terminal side to the bus side, and the direction of data receiving is from the bus side to the terminal side. Data transfer is noninverting in both directions.

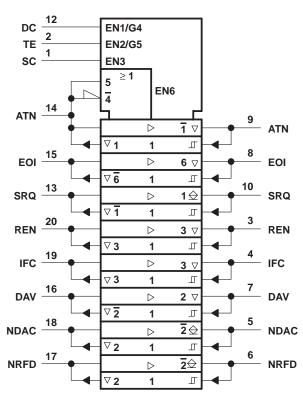
CHANNEL IDENTIFICATION TABLE

NAME	IDENTITY	CLASS
DC	Direction Control	
TE	Talk Enable	Control
SC	System Control	
ATN	Attention	
SRQ	Service Request	
REN	Remote Enable	Bus Management
IFC	Interface Clear	
EOI	End or Identify	
DAV	Data Valid	
NDAC	No Data Accepted	Data Transfer
NRFD	Not Ready for Data	

[†] ATN is a normal transceiver channel that functions additionally as an internal direction control or talk enable for EOI whenever the DC and TE inputs are in the same state. When DC and TE are in opposite states, the ATN channel functions as an independent transceiver only.

SLLS020C - JUNE 1986 - REVISED MAY 1995

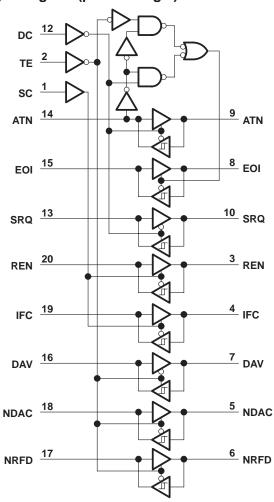
logic symbol†



- † This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
- ∇ Designates 3-state outputs

Pin numbers shown are for the N package.

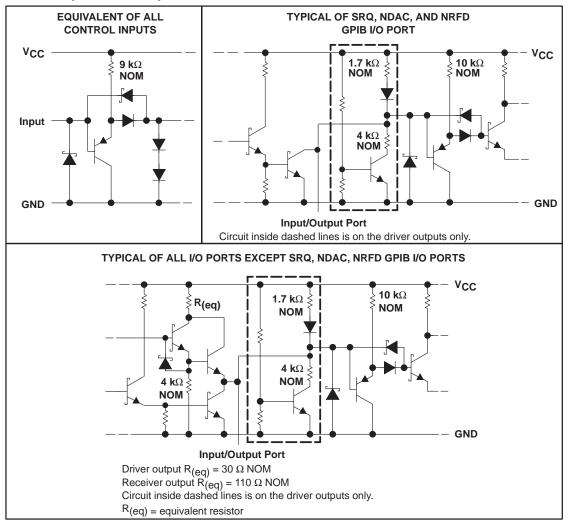
logic diagram (positive logic)





SLLS020C - JUNE 1986 - REVISED MAY 1995

schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)	
Input voltage, V _I	
Low-level driver output current, I _{OL}	100 mA
Continuous total dissipation	. See Dissipation Rating Table
Operating free-air temperature range, T _A	0°C to 70°C
Storage temperature range, T _{stq}	– 65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from the case for 10 seconds	260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to network ground terminal.



SLLS020C - JUNE 1986 - REVISED MAY 1995

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{\scriptsize A}} \le 25^{\circ}\mbox{\scriptsize C}$ POWER RATING	DERATING FACTOR	T _A = 70°C POWER RATING
DW	1350 mW	10.8 mW/°C	864 mW
N	1700 mW	13.6 mW/°C	1088 mW

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.75	5	5.25	V
High-level input voltage, VIH					V
Low level input voltage, V _{IL}				0.8	V
High level cutout current leve	Bus ports with 3-state outputs			- 5.2	mA
High-level output current, IOH	Terminal ports			- 800	μΑ
Lour lovel output output	Bus ports			48	A
Low-level output current, IOL	Terminal ports			16	mA
Operating free-air temperature, T _A				70	°C

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER		TEST	MIN	TYP [†]	MAX	UNIT		
VIK	Input clamp voltage		I _I = -18 mA			- 0.8	-1.5	V	
V _{hys}	Hysteresis voltage (V _{IT+} - V _{IT-})	Bus				0.65		V	
Vo. T	High-level output voltage	Terminal	I _{OH} = -800 μA		2.7	3.5		V	
VOH [‡]	Tilgit-level output voltage	Bus	I _{OH} = -5.2 mA			3.3		v	
VOL	Low-level output voltage	Terminal	I _{OL} = 16 mA			0.3	0.5	V	
VOL	Low-level output voltage	Bus	$I_{OL} = 48 \text{ mA}$			0.35	0.5	V	
lį	Input current at maximum input voltage Terminal		V _I = 5.5 V			0.2	100	μΑ	
lн	High-level input current	Terminal and	V _I = 2.7 V			0.1	20	μΑ	
I _Ι L	Low-level input current	control inputs	V _I = 0.5 V	V _I = 0.5 V		-10	-100	μΑ	
Vuon	Voltage at bus port		Driver disabled	$I_{I(bus)} = 0$	2.5	3.0	3.7	V	
VI/O(bus)	voltage at bus port	-		$I_{I(bus)} = -12 \text{ mA}$			-1.5	V	
	Current into bus port	Power on	Driver disabled	$V_{I(bus)} = -1.5 \text{ V to } 0.4 \text{ V}$	-1.3				
				$V_{I(bus)} = 0.4 \text{ V to } 2.5 \text{ V}$	0		- 3.2		
I _{I/O(bus)}				V _{I(bus)} = 2.5 V to 3.7 V			+ 2.5 - 3.2	l m A	
()				V _{I(bus)} = 3.7 V to 5 V	0		2.5		
				$V_{I(bus)} = 5 V \text{ to } 5.5 V$	0.7		2.5		
		Power off	$V_{CC} = 0$,	$V_{I(bus)} = 0 \text{ to } 2.5 \text{ V}$			- 40	μΑ	
laa	Short-circuit output	Terminal			-15	- 35	-75	mA	
los	current	Bus			- 25	- 50	-125		
Icc	Supply current		No load,	TE, DC, and SC low		55	75	mA	
C _{I/O(bus)}	C _{I/O(bus)} Bus-port capacitance			$V_{I/O} = 0$ to 2 V, f = 1 MHz		30		pF	

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ V_{OH} applies to 3-state outputs only.



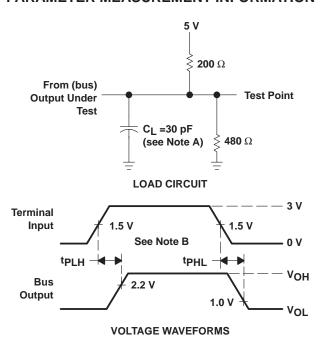
SLLS020C - JUNE 1986 - REVISED MAY 1995

switching characteristics over recommended range of operating free-air temperature, $V_{CC} = 5 \text{ V}$

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN T	YP†	мах	UNIT
^t PLH	Propagation delay time, low- to high-level output	Terminal	Bus	C _L = 30 pF,		10	20	50
tPHL	Propagation delay time, high- to low-level output	reminai	Dus	See Figure 1		12	20	ns
^t PLH	Propagation delay time, low- to high-level output	Bus	Terminal	C _L = 30 pF, See Figure 2		5	10	ns
tPHL	Propagation delay time, high- to low-level output	Bus				7	14	
^t PZH	Output enable time to high level		Bus (ATN, EOI, REN, IFC, and DAV)	C _L = 15 pF, See Figure 3			30	ns
t _{PHZ}	Output disable time from high level	TE, DC, or SC					20	
t _{PZL}	Output enable time to low level	12, 00, 0130					45	
tPLZ	Output disable time from low level						20	
^t PZH	Output enable time to high level						30	
^t PHZ	Output disable time from high level	TE, DC, or SC	Terminal	C _L = 15 pF, See Figure 4			25	
tPZL	Output enable time to low level	16, 50, 6130					30	ns
tPLZ	Output disable time from low level						25	

[†] All typical values are at $T_A = 25$ °C.

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

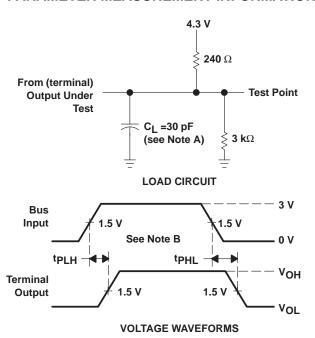
B. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $t_r \leq$ 6 ns, $t_f \leq$ 8 ns = 50 Ω .

Figure 1. Terminal-to-Bus Load Circuit and Voltage Waveforms



SLLS020C - JUNE 1986 - REVISED MAY 1995

PARAMETER MEASUREMENT INFORMATION

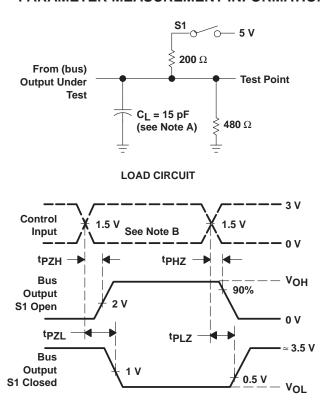


NOTES: A. C_L includes probe and jig capacitance.

B. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $t_{\rm f} \leq$ 6 ns, $t_{\rm f} \leq$ 7 ns, $t_{\rm f} \leq$ 8 ns, $t_{\rm f} \leq$ 9 ns, $t_{$

Figure 2. Bus-to-Terminal Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION



VOLTAGE WAVEFORMS

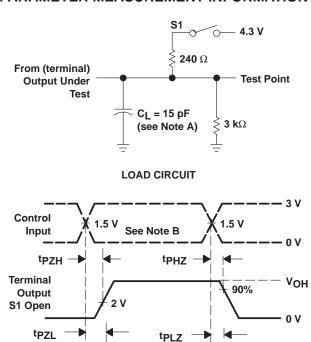
NOTES: A. C_L includes probe and jig capacitance.

B. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $t_{\Gamma} \leq$ 6 ns, $t_{\Gamma} \leq$ 6 ns, $t_{\Gamma} \leq$ 6 ns, $t_{\Gamma} \leq$ 7 ms, $t_{\Gamma} \leq$ 8 ns, $t_{\Gamma} \leq$ 8 ns, $t_{\Gamma} \leq$ 9 ns, $t_{\Gamma} \leq$

Figure 3. Bus Load Circuit and Voltage Waveforms

VOL

PARAMETER MEASUREMENT INFORMATION



VOLTAGE WAVEFORMS

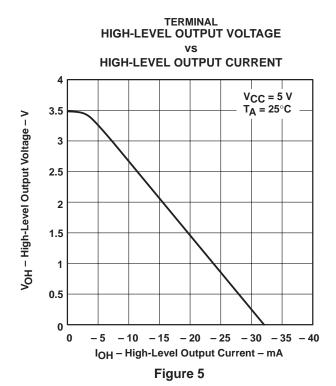
NOTES: A. C_L includes probe and jig capacitance.

Terminal Output S1 Closed

B. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, 50% duty cycle, $t_f \leq$ 6 ns, $t_f \leq$ 6 ns, $t_O =$ 50 $t_O =$ 50

Figure 4. Terminal Load Circuit and Voltage Waveforms

TYPICAL CHARACTERISTICS



TERMINAL LOW-LEVEL OUTPUT VOLTAGE vs LOW-LEVEL OUTPUT CURRENT 0.6 V_{CC} = 5 V $T_A = 25^{\circ}C$ V_{OL} – Low-Level Output Voltage – V 0.5 0.4 0.3 0.2 0.1 0 0 20 30 40 50 60 IOL - Low-Level Output Current - mA Figure 6

TERMINAL OUTPUT VOLTAGE

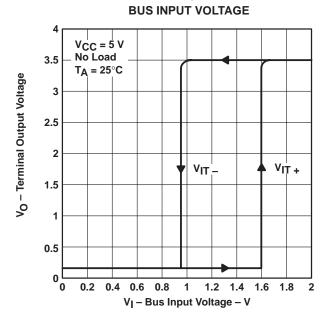
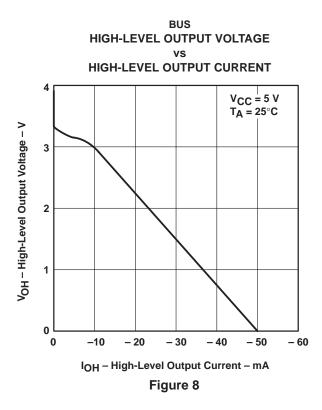
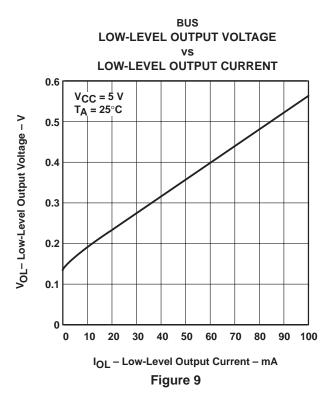
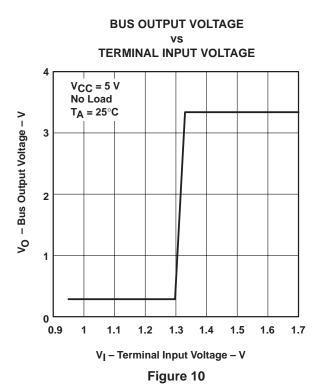


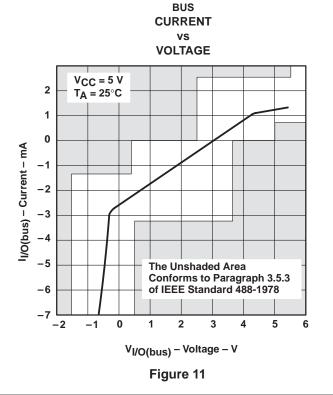
Figure 7

TYPICAL CHARACTERISTICS









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